

2N6182 thru 2N6185 (SILICON)
2N6186 thru 2N6189

MEDIUM-POWER PNP SILICON TRANSISTORS
 . . . designed for switching and wide-band amplifier applications.

- Low Collector-Emitter Saturation Voltage –
 $V_{CE(sat)} = 1.2 \text{ Vdc (Max) @ } I_C = 10 \text{ Adc}$
- DC Current Gain Specified to 5 Amperes
- Excellent Safe Operating Area
- Packaged in the Compact, High Dissipation TO-59 Case
- Isolated Collector Configuration
- 2N6182 thru 2N6185 Complement to NPN 2N5477 thru 2N5480
 2N6186 thru 2N6189 Complement to NPN 2N5346 thru 2N5349

**10 AMPERE
 POWER TRANSISTORS**
PNP SILICON
80-100 VOLTS
60 WATTS

***MAXIMUM RATINGS**

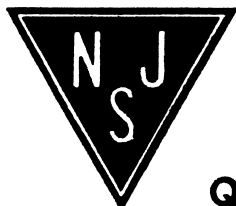
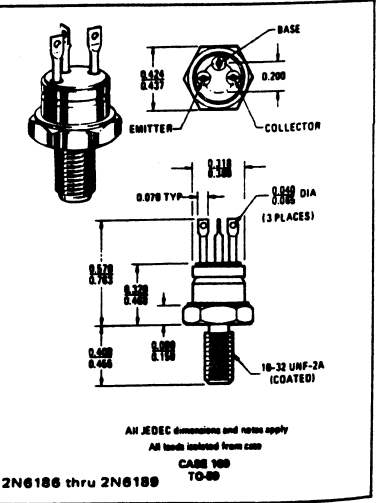
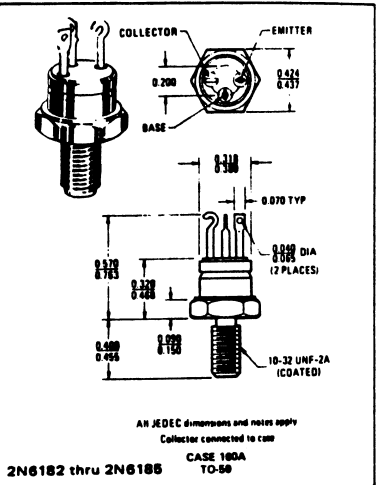
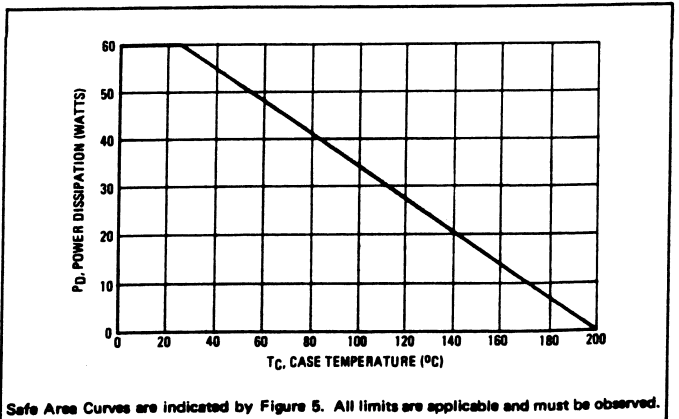
Rating	Symbol	2N6182 2N6183 2N6186 2N6187	2N6184 2N6185 2N6188 2N6189	Unit
Collector-Emitter Voltage	V_{CEO}	80	100	Vdc
Collector-Base Voltage	V_{CB}	80	100	Vdc
Emitter-Base Voltage	V_{EB}	6.0		Vdc
Collector Current – Continuous	I_C	10		Adc
Base Current	I_B	2.0		Adc
Total Device Dissipation @ $T_C = 25^\circ\text{C}$ Derate above 25°C	P_D	60	343	Watts mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	T_J, T_{stg}	-65 to +200		$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	θ_{JC}	2.91	$^\circ\text{C/W}$

*Indicates JEDEC Registered Data

FIGURE 1 – POWER-TEMPERATURE DERATING



2N6182 thru 2N6185, 2N6186 thru 2N6189 (continued)

* ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Characteristic	Fig. No.	Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector-Emitter Sustaining Voltage (1) (I _C = 50 mA, I _B = 0)	—	V _{CEO(sus)}	80 100	—	Vdc
Collector Cutoff Current (V _{CE} = 75 Vdc, I _B = 0) (V _{CE} = 90 Vdc, I _B = 0)	—	I _{CEO}	—	100 100	μAdc
Collector Cutoff Current (V _{CE} = 75 Vdc, V _{BE(off)} = 1.5 Vdc) (V _{CE} = 90 Vdc, V _{BE(off)} = 1.5 Vdc) (V _{CE} = 75 Vdc, V _{BE(off)} = 1.5 Vdc, T _C = 150°C) (V _{CE} = 90 Vdc, V _{BE(off)} = 1.5 Vdc, T _C = 150°C)	12	I _{CEx}	—	10 10	μAdc
Collector Cutoff Current (V _{CB} = Rated V _{CB} , I _E = 0)	—	I _{CBO}	—	10	μAdc
Emitter Cutoff Current (V _{BE} = 6.0 Vdc, I _C = 0)	—	I _{EBO}	—	100	μAdc
ON CHARACTERISTICS (1)					
DC Current Gain (I _C = 0.5 Adc, V _{CE} = 2.0 Vdc) (I _C = 2.0 Adc, V _{CE} = 2.0 Vdc) (I _C = 5.0 Adc, V _{CE} = 2.0 Vdc)	8	h _{FE}	30 60 30 60 20 40	— — 120 240 — —	—
Collector-Emitter Saturation Voltage (I _C = 2.0 Adc, I _B = 0.2 Adc) (I _C = 10 Adc, I _B = 1.0 Adc)	9, 10, 11	V _{CE(sat)}	—	0.7 1.2	Vdc
Base-Emitter Saturation Voltage (I _C = 2.0 Adc, I _B = 0.2 Adc) (I _C = 10 Adc, I _B = 1.0 Adc)	10, 11	V _{BE(sat)}	—	1.2 2.0	Vdc
DYNAMIC CHARACTERISTICS					
Current-Gain-Bandwidth Product (2) (I _C = 500 mA, V _{CE} = 10 Vdc, f _{Test} = 10 MHz)	—	f _T	30	—	MHz
Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f = 100 kHz)	7	C _{ob}	—	300	pF
Input Capacitance (V _{BE} = 2.0 Vdc, I _C = 0, f = 100 kHz)	7	C _{ib}	—	1250	pF
SWITCHING CHARACTERISTICS					
Delay Time (V _{CC} = 40 Vdc, V _{BE(off)} = 3.0 Vdc, I _C = 2.0 Adc, I _{B1} = 200 mA)	2, 3	t _d	—	100	ns
Rise Time (I _C = 2.0 Adc, I _{B1} = 200 mA)	—	t _r	—	100	ns
Storage Time (V _{CC} = 40 Vdc, I _C = 2.0 Adc, I _{B1} = I _{B2} = 200 mA)	2, 6	t _s	—	2.0	μs
Fall Time (I _{B1} = I _{B2} = 200 mA)	—	t _f	—	200	ns

*Indicates JEDEC Registered Data
 (1) Pulse Test: Pulse Width ≈ 300 μs, Duty Cycle ≈ 2.0%.
 (2) f_T = I_{hfe1} · f_{Test}

FIGURE 2 - SWITCHING TIME TEST CIRCUIT

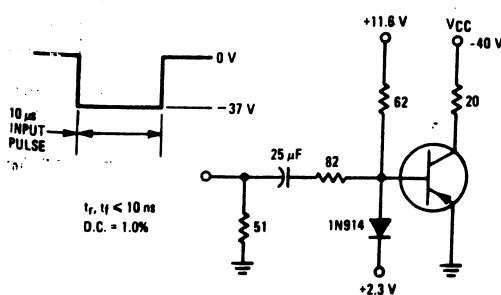


FIGURE 3 - TURN-ON TIME

